SS1FH6

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Vishay General Semiconductor

Surface-Mount Schottky Barrier Rectifiers



Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	1.0 A		
V _{RRM}	60 V		
I _{FSM}	40 A		
V_F at I_F = 1.0 A (T_A = 125 °C)	0.56 V		
T _J max.	175 °C		
Package	SMF (DO-219AB)		
Circuit configuration	Single		

FEATURES

- Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test **Polarity:** color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SS1FH6	UNIT	
Device marking code		16		
Maximum repetitive peak reverse voltage	V _{RRM}	60	V	
Maximum average forward rectified current (fig.1)	I _{F(AV)} ⁽¹⁾	1.0	А	
Peak forward surge current 8.3 ms single half sine-wave $T_{J \text{ (init)}} = 25 \text{ °C}$	I _{FSM}	40	А	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C	

Note

 $^{(1)}\,$ Free air, mounted on recommended copper pad area

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COMPLIANT

HALOGEN

FREE

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 0.7 A	– T _A = 25 °C		0.60	-	V
	I _F = 1.0 A		V _E ⁽¹⁾	0.64	0.70	
	I _F = 0.7 A	- T _A = 125 °C	VF	0.53	-	
	I _F = 1.0 A			0.56	0.61	
Reverse current	V 60.V	T _A = 25 °C T _A = 125 °C	I _R ⁽²⁾	-	3	μA
	V _R = 60 V			90	450	
Typical junction capacitance	4.0 V, 1 MHz		CJ	90	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted)				
PARAMETER	SYMBOL	SS1FH6	UNIT	
Typical thermal resistance	R _{0JA} (1)(2)(3)	125	°C/W	
	R _{0JM} (1)(2)(3)	21	0/10	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

⁽²⁾ Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$ Thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS1FH6-M3/H	0.015	Н	3000	7" diameter plastic tape and reel	
SS1FH6-M3/I	0.015	l	10 000	13" diameter plastic tape and reel	
SS1FH6HM3/H ⁽¹⁾	0.015	Н	3000	7" diameter plastic tape and reel	
SS1FH6HM3/I ⁽¹⁾	0.015	I	10 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

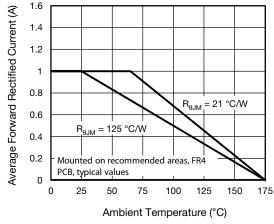
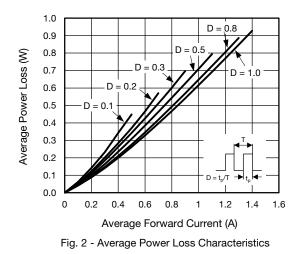
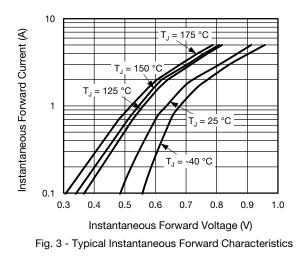


Fig. 1 - Maximum Forward Current Derating Curve





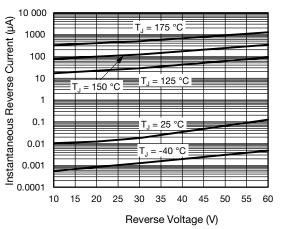


Fig. 4 - Typical Reverse Leakage Characteristics

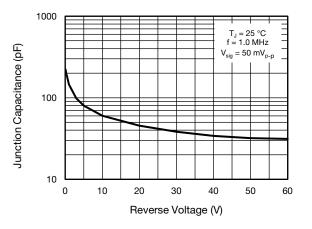


Fig. 5 - Typical Junction Capacitance

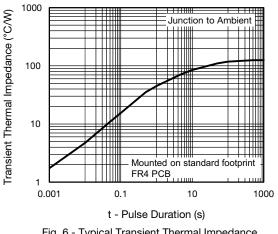


Fig. 6 - Typical Transient Thermal Impedance

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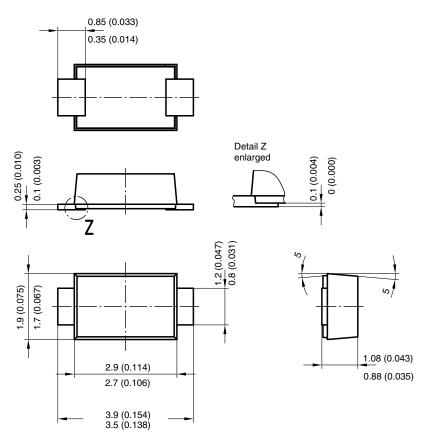
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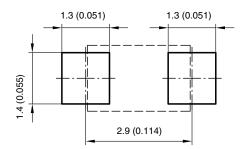
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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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